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CURRENT SITUATION OF THE DEVELOPMENT AND MANUFACTURE OF VARY LARGE SCALE INTEGRATED DEVICES IN CHINA



bу

He Yubiao



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By: He Yubiao

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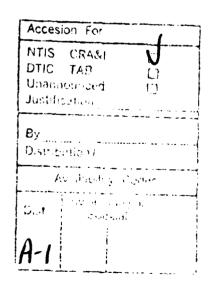
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CURRENT SITUATION OF THE DEVELOPMENT AND MANUFACTURE OF VARY LARGE SCALE INTEGRATED DEVICES IN CHINA

Yubiao He

China's VLSI device industry, no matter whether various memory devices, or CPU's and their interfacing devices, is still in the developmental and small-quantity production stage. However, great successes have been achieved during the sixth Five-Year-Plan. The currently achieved technological level for NMOS production lines are on the order of 4-6 μ m. A number of production lines have been developed for HMOS-I and HCMOS-I devices on the order of 2.5-3.5 μ m. It is predicted that the research and manufacture of CMOS devices will be emphasized in the future. The development of STTL and LSTTL devices, mostly medium— and small—scale, was also outstanding during the past two years. Recently developed and current on—line products of LSI (VLSI) devices are listed in the attached tables. The highest technological levels achieved presently by domestic NMOS devices are: 64K-bit DRAM (developed and manufactured by the 24th Research Institute and the 742th Factory of the Ministry of Electronic Industry

(MEI)); 16K-bit (2K-byte) single-source EPROM (47th Research Institute of MEI); 68B00 8-bit micro-processor (µp) (47th Research Institute of MEI); 8085 8-bit µp (Qinghua University and the 5th Electronic Device Factory in Shanghai). In addition, CMOS, TTL and ECL devices have achieved 1K-bit high-speed SRAM and single-chip 10-bit D/A converter (47th Research Institute of MEI) and 8-bit A/D converter.

Containing 100,000 and 150,000 elements, respectively, the 16K SRAM, developed by Qinghua University in 1985, and the 64K DRAM, jointly developed by the 47th Research Institute and the 742th Factory of MEI, are the first VLSI devices independently and successfully developed in our country, indicating that China has entered the VLSI era.

However, due to the severe constraints of manufacturing equipment, testing techniques, ultra-pure material and ultra-clean environment, the qualification rate of our LSI products are too low to be put into large-quantity production, except for a few imported production lines.

In the development and manufacture of micro-processors, CMOS 1-bit micro-processor 14500 is compatible with the MC14500 by Motorola. Due to the ease of manufacture resulting from the relative simple small-scale structure and the small number of required interfacing devices which are presently available, the 14500 µP has now been put

into large-quantity production at the 5th Electronic Device Factory in Shanghai, the 14th Radio Factory in Shanghai, and the Semiconductor Device Factory in Beijing, etc., and has achieved an increasing number of domestic applications.

Many domestic factories/companies manufacture NMOS or PMOS, single-chip or multi-chip, 4-bit micro-processors. These products, designed domestically, are not compatible with foreign 4-bit micro-processors, which greatly limit their applications.

As for 8-bit micro-processors, the 8080A, developed by the 5th Electronic Device Factory in Shanghai, and the 8085, jointly developed by Qinghua University and the 5th Electronic Device Factory in Shanghai, have been qualified. Some series of interfacing devices have also been developed. However, due to the incompleteness of the required interfacing devices, especially large-scale integrated interfacing devices, those micro-processors mentioned above have not yet been put into mass production.

The 6800 Series 8-bit micro-processors, which have been put into production at several factories, are mainly developed by the 47th Research Institute of MEI. In addition to the 6800, 68A00 and 68B00 micro-processors, that Institute has also successfully developed a variety of rather complete series of interfacing devices, and therefore are ready for industrial production. This is a major

achievement in the research and development of VLSI devices during the sixth Five-Year-Plan period.

The manufacture of LSI and VLSI devices in foreign countries is a highly competitive high-tech industry. It requires high-precision manufacturing technology, and very expensive manufacturing equipment. Therefore, it is impossible to conduct research and form industrial production capability by merely relying on obsolete manufacturing equipment and semi-manual production techniques. According to the experience of our foreign counterparts and based on our current situation, it is highly desirable for domestic LSI and VLSI research institutes and manufacturers to establish unified development-manufacturing units, concentrate resources, available funds to upgrade equipment and technology, improve management, conduct theoretical research, and develop new technology and new devices under a unified planning and assigned responsibility. It is only in this way that we can reduce the gap between domestic and foreign VLSI device industries, and promote our micro-electronic industry. This should be the trend for the development of the microelectronic industry in China.

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Table 1. Static random access memory (SRAM)

| Domestic Product | Foreign Product | Size (bit) | Techno- logy | Accessing Time (ns) | Cycle Time (ns) | |
|---------------------|--------------------|---------------|-----------------|------------------------|-----------------|--|
| W6810 | MCM6810 | 128X8 | NMOS | 575 | 575 | |
| LN6810 | 11 | 11 | 11 | 250 | 370 | |
| 11 | 11 | " | 11 | 360 | 360 | |
| 5G2102 | 2102 | 1k×1 | 11 | 250 | 250 | |
| DG2102 | C2102 | " | 11 | 450 | 450 | |
| W2115 | 2115 | " | HMOS | 45 | 45 | |
| DG2114 | C2114 | 1k×4 | NMOS | 450 | 450 | |
| W2114 | 2114 | " | 11 | 350 | 350 | |
| 5G2114 | 11 | " | 11 | 200 | 200 | |
| W2147 | 2147 | 4kX1 | HMOS | 70 | 70 | |
| 16KSRAM | | 2kX8 | 11 | | | |
| 5G5101 | MCM145101 | 256X4 | CMOS | 450 | 450 | |
| IM6508 | IM6508 | 1k×1 | " | 300 | 300 | |
| HCM6562 | | 256X4 | HCMOS | 75 | 75 | |
| 93415 | 93415 | lk×1 | TTL | 45 | | |
| MCM10146 | MCM10146 | " | ECL | 25 | | |

Table 2. Dynamic random access memory (DRAM)

| Domestic Product | Foreign Product | Size (bit) | Techno- logy | Accessing Time (ns) | Cycle Time (ns) |
|---------------------|--------------------|---------------|-----------------|------------------------|-----------------|
| DG0031 | | 4k×1 | NMOS | 450 | 695/500 |
| DG4027 | MCM4027 | 11 | 11 | 250 | 375 |
| CN2107 | • | 11 | " | 400 | 600 |
| W4116 | MCM4116 | 16k×1 | HMOS | 375 | 700 |
| 4864 | 4864 | 64k×1 | 11 | (200) | (300) |

Table 3. Read-only memory (ROM) and erasible read-only memory (EPROM) (NMOS devices)

| Domestic Product | Foreign Product | Function | Size (bit) | Read time (ns) | Cycle Time (ns) |
|---------------------|---------------------|------------------------|------------------------|----------------|--------------------|
| LN6830 LN6830A | MCM6830 | Fixed ROM | 1kx8 | 300 350 | 350 |
| W6830 LN2708 | " MCM2708 | " EPROM | 11 | 500 350 | 500 |
| I2708 5G2708 | i2708 | " | 11 11 | 450 450 | |
| DG2708 LN2716 | MCM2708 MCM2716 | " | 2k×8 | 450 450 | |
| DG0016 | | Character generator | 5X7matrix 64 char. | | |
| DG0015 | | 11 | 5X7matrix 96 char. | | |
| LN6674 | | " | 5X7matrix 128 char. | | |

Table 4. General medium- and small-scale LSTTL interfacing devices

| Product | Device name and function |
|------------|--|
| 74LS125 | 4-bit bus buffer (three-state, non-inverting) |
| 54LS125 | n ' |
| 74LS126 | II . |
| 54LS126 | 11 |
| 74LS365 | 6-bit bus driver (three-state, non-inverting) |
| 54LS365 | n ' |
| 74LS366 | 6-bit bus driver (three-state, inverting) |
| 74LS367 | 6-bit bus driver (three-state, non-inverting) |
| 54LS367 | n ' |
| 74SS368 | 6-bit bus driver (three-state, inverting) |
| 54LS368 | li . |
| 74LS240 | 8-bit bus driver (three-state, inverting) |
| 74LS244 | 8-bit bus buffer/driver (three-state, non-inverting) |
| 54LS244 | ii ii |
| 74/54LS245 | 8-bit bus transceiver (three-state, non-inverting) n |
| 74/54LS251 | 8-to-1 multiplexer/modulator (three-state) |
| 74/54LS253 | Dual 4-input multiplexer(three-state) |
| 74/54LS257 | 4-channel 2-input multiplexer (three-state) |

Table 5. MC14500 CMOS 1-bit micro-processor dedicated interfacing devices (CMOS)

| Domestic Product | Foreign Product | Device name (function) |
|---------------------|--------------------|---|
| 5G14512 | MC14512 | 8 channel multiplexer |
| 5G14516 | MC14516 | 4-bit reversible binary counter with preset |
| 5G14599 | MC14599 | 8-bit addressable bidirectional latch |

Table 6. 2901 LSTTL 4-bit single-chip computer dedicated interfacing devices

| Domestic Product | Foreign Product | Device name (function) |
|--|------------------------|---|
| ER2902/M ER2910/M ER2905/M ER2918/M | AM2910C/M AM2905C/M | Look-ahead carry generator 12-bit sequencer 2-input OC bus transceiver 4-bit D flip-flop |

Table 7. 4-bit micro-processor interfacing devices

| Product | Technology | Device name | Type of computers used for |
|-------------------------------|------------|---------------|--|
| 040-5 5205/5205A DG0046 | | Sync. decoder | DJS-040 PMOS 4-bit computer 051 NMOS 4-bit computer DG004 and DG0401 4-bit computer |

| Product | Foreign Product | Techi | | Device Name (Function) |
|---|---|--|---|--|
| 8216 | i8216 | STTL | | 4-bit bi-directional bus dr |
| 5216/5216A 8226 | i8226 | NMOS STTL | | " |
| 8212 | i8212 | 10111 | | 8-bit I/O port |
| 5212/5212A 8224 | i8224 | NMOS STTL | | " Clock generator/driver |
| 0224 | 10224 | SIIL | | Clock generator/driver |
| 5G8251 | i8251 | NMOS | | Universal programmable com tion port (USART) |
| 5G8253 | i8253 | " | | Programmable timer |
| 5G8255 | i8255 | ,,, | | Programmable 8-bit Paralle port |
| 5G8257 | i8257 | ** | | Programmable DMA controlle |
| 5G8259 | i8259 | " | | Programmable interrupt con |
| | i8279 | ,, | | 1_ |
| | | ies in | nterf | Programmable key board/disport acing devices |
| Table 9. 1 | MC6800 ser | | | port |
| Table 9. 1 Product 6877/8T97 | MC6800 ser Technol | ogy D | evice Ni-di | acing devices Name (Function) rectional three-state buffe |
| Table 9. 1 Product 6877/8T97 6880A/8T26 | MC6800 ser Technol STTL | ogy De | evice Ni-di: -bit | acing devices Name (Function) rectional three-state buffe three-state bus transceiver |
| Table 9. 1 Product 6877/8T97 | MC6800 ser Technol | ogy De | evice Ni-di: -bit 1 | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B3 | MC6800 ser Technol STTL " NMOS | Ogy De UI | evice Ni-di -bit 800 c | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B3 | MC6800 ser Technol STTL " NMOS | Ogy De UI 4- | evice Ni-di -bit 800 c eripho | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (Pummable timer |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B3 | MC6800 ser Technol STTL " NMOS " " | Ogy De UI 4- | evice Ni-di: -bit = 800 c. eripho | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 | Technol STTL " NMOS " " " | Ogy De UI 4- | evice Ni-di: -bit 800 c; eriphorman | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P mmable timer ntroller (DMAC) ntroller (CRTC) |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 68A50/68/B2 | Technol STTL " NMOS " " " | De Properties de la companya del companya de la companya del companya de la compa | evice Ni-di: -bit : 800 c: eriphe rogram MA com RT com sync. | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P mmable timer ntroller (DMAC) ntroller (CRTC) communication interfacing |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 | Technol STTL " NMOS " " " " " " " " " " " " " " " " " " " | De Properties de la companya del companya de la companya del companya de la compa | evice Ni-di: -bit : 800 c: eriphe rogram MA com RT com sync. | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P mmable timer ntroller (DMAC) ntroller (CRTC) |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 68A50/68/B2 68A52/68B52 68A52/68B52 | MC6800 ser Technol STTL NMOS 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | De Ci As | evice Ni-di -bit 800 c eriphe rogram MA com RT com sync. | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P mmable timer ntroller (DMAC) ntroller (CRTC) communication interfacing series data adapter (SSDA) ed data link controller |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 68A50/68/B2 68A52/68B52 68A52/68B52 68A52/68B52 | MC6800 ser Technol STTL NMOS 1 1 1 1 1 1 1 1 1 1 1 1 1 | De CI As Sy | evice Ni-di -bit 800 c eriphe rogram MA com RT com sync. ync. | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P "mmable timer ntroller (DMAC) ntroller (CRTC) communication interfacing series data adapter (SSDA) ed data link controller baud modem |
| Table 9. 1 Product 6877/8T97 6880A/8T262 6875 6820 6821/A21/B2 6840 6844 6845 6850 68A50/68/B2 68A52/68B52 68A52/68B52 | MC6800 ser Technol STTL NMOS 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | De CI As Ac O C 2 4 | evice Ni-di: -bit : 800 c. eripho rogram MA com RT com sync. ync. : dvance -600 l | acing devices Name (Function) rectional three-state buffe three-state bus transceiver lock generator/driver eral interfacing adapter (P mmable timer ntroller (DMAC) ntroller (CRTC) communication interfacing series data adapter (SSDA) ed data link controller |

| Product | Technology | Device Name (Function) |
|--------------------|------------|--|
| 6877/8 T 97 | STTL | UNi-directional three-state buffer |
| 6880A/8T26A | 11 | 4-bit three-state bus transceiver |
| 6875 [^] | 11 | 6800 clock generator/driver |
| 6820 | NMOS | Peripheral interfacing adapter (PIA) |
| 6821/A21/B21 | 11 | и , , , |
| 6840 | 11 | Programmable timer |
| 6844 | 11 | DMA controller (DMAC) |
| 6845 | 11 | CRT controller (CRTC) |
| 6850 | f1 | Async. communication interfacing adapter |
| 68A50/68/B50 | 11 | II . |
| 6852 | 11 | Sync. series data adapter (SSDA) |
| 68A52/68B52 | 11 | " |
| 6854 | 11 | Advanced data link controller |
| 6860 | ** | 0-600 baud modem |
| 6862 | ** | 2400 baud digital modulator |
| 68488 | 41 | General interfacing adapter |
| 6674 | ** | 128 5X7 dot matrix character generator |

Table 10. Single-Chip D/A Converter (DAC)

| Domestic Product | Foreign Product | Resolu- tion(bit) | Accuracy | Conver- sion mode | Settling time (us) |
|---------------------|--------------------|----------------------|-----------|----------------------|-----------------------|
| X80 | LM1408 | 8 | 0.19-0.78 | | 0.3 |
| LDA08C | | 8 | 0.2 | l e | 0.3 |
| LT1508 | MC1508 | 8 | 0.2 | l e | 0.3-0.4 |
| LAZOS | Ì | 8 | 0.2 | e | 0.4 |
| FDA0808 | CDAC0808 | 8 | 0.2 | # | 0.15 |
| 4E602 | | 8-10 | 0.2 | # | 0.8 |
| 5G7520 | AD7520 | 8-10 | 0.05 | " | 0.5 |
| LDA3410 | MC3410 | 10 | 0.05 | l e | 0.25 |

Table 11. Single-Chip A/D Converter (ADC)

| Domestic Product | Foreign Product | Resolu- tion(bit) | Accuracy | Conver- sion mode | Settling time (ms) | |
|---------------------|--------------------|----------------------|----------|----------------------|-----------------------|--|
| 5G14433 | MC14433 | 3.5 | 0.05 | \$ | 100 | |
| FMC14433 | 11 | 3.5 | 0.05 | \$ | 40 | |
| CH7106 | ICL7106 | 3.5 | 0.1 | \$ | 300 | |
| FADC0808 | CADC0808 | 8 | 0.5 | & | 0.1 | |
| 5G0801 | ADC0801 | 8 | ±1/4 LSB | & | 0.1 | |
| 5G0802 | ADC0802 | 8 | ±1/4 LSB | & | 0.1 | |
| CMOS A/DC | 1 | 8 | 0.5 | & | 0.016 | |

Note: 1. In Table 10, all DAC's are TTL except 5G7520, which is CMOS.

- 2. In the "Conversion Mode" column, @ indicates "current switch type", and # indicates "multiplicative type".
- 3. In Table 11, all ADC's are CMOS.
- 4. In the "Conversion Mode" column, \$ indicates "dual-integral type", and & indicates "successive comparison type".

Table 12. Micro-Prodessors (µP)

| Domestic Product | Foreign Product | | | Basic Com- mand | Max. Freq. (MHz) | Address- ability (byte) | Inter- rupt Mode | No. of General Rgstr. | Stack Level | |
|---------------------|--------------------|----|-------|-----------------------|------------------------|-------------------------------|------------------------|-----------------------------|----------------|---|
| 5G14500 | MC14500 | 1 | CMOS | 16 | 1.0 | | | 1 | | |
| DH14500 | 11 | 1 | ** | 16 | 1.0 | ľ | ł | 1 | 1 | 1 |
| CH4500B/C | 11 | 1 | " | 16 | 1.0 | | ļ | 1 | ł | |
| DJS040*1 | } | 4 | PMOS | 45 | 0.1 | 1k | 1 | 1 | 1 | 1 |
| DG0040*2 | ! | 4 | NMOS | 48 | 0.15 | 8k | | 1 | ł | |
| DG00401*3 | 1 | 4 | n | 68 | 0.15 | 2K | } | 1 | J |] |
| DG420 | Ì | 4 | M | 49 | 4.0 | 1K | | | 1 | ı |
| ER2901 | AM2901C | 4 | LSTTL | 512- | 9.5 | 256/256 | Multi- | | Multi | 4 |
| | | | | micro | l | | level | | level | [|
| ER2901A | AM2901A | 4 | " | " | 15.0 | 256/256 | " | 1 | " | 4 |
| ER2901M | AM2901M | 4 | " | 11 | 8.3 | 256/256 | " | ĺ | " | 4 |
| ER2901AM | AM2901M | 4 | 11 | " | 12.0 | 256/256 | " | 1 | " | 4 |
| 5G8080 | 18080A | 8 | NMOS | 72 | 2.0 | 64k/512 | " | 6 |) " | 7 |
| 5G8085 | i8085 | 8 | 11 | 74 | 3.0 | 64k/512 | | 6 | " | 7 |
| 8085 | 18085 | 8 | " | 74 | 3.0 | 64k/512 | 1 11 | 6 | } " | 7 |
| LN6800 | MC6800 | (8 | • | 72 | 1.0 | 64k | •• | 6 | 11 | 7 |
| W6800 | MC6800 | 8 | " | 72 | 1.0 | 64k | " | 6 | ** | 7 |
| DG6800 | MC6800 | 8 | " | 72 | 1.0 | 64k | ** | 6 | 1 11 | 7 |
| LN68A00 | MC68A00 | 8 | " | 72 | 1.5 | 64k | " | 6 | " | 7 |
| LN68B00 | MC68B00 | 8 | 111 | 72 | 2.0 | 64k | " | 6 | 1 " | 7 |

Note: *1—two-chip CPU; *2—CPU/RAM/ROM three-chip computer; *3—CPU/RAM/ROM three-chip computer. All others are single-chip μP's.

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